

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUN HWA CHOI	09/06/2019
SOON SEONG CHOI	09/06/2019
JEONG HUN CHO	09/06/2019
RECEIVING PARTY DATA	
Name:	JMJ KOREA CO., LTD.
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City:	BUCHEON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	14487
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16563957
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NAME OF SUBMITTER:	ANDREW S. PARK
SIGNATURE:	/Andrew S. Park/
DATE SIGNED:	09/09/2019
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,	Yun Hwa CHOI, Soon Seong CHOI and JEONG HUN CHO (hereinafter designated as the undersigned),
respectively, has (have) invented certain new and useful improvements in:	
PRESS-FIT PIN, SEMICONDUCTOR PACKAGE HAVING THE SAME AND METHOD FOR MANUFACTURING THE PRESS-FIT PIN	
for which an application for Letters Patent was executed by the undersigned	

for Application No.	16/563,957	, Filed	September 9, 2019	, and
WHEREAS,	JMJ Korea Co., Ltd.			
(hereinafter referred to as "Assignee") having a place of business at:				
102, Gilju-ro 425beon-gil, Bucheon-si, Gyeonggi-do 14487, Republic of Korea				

is desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefore in the United States of America and in any foreign countries;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefore in the United States of America, its territories, dependencies and possessions, and in any and all foreign countries and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue application thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with any interference which may be declared concerning this application.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from

said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of Park, Kim & Suh, LLC, 1875 Century Park East, Suite #600, Los Angeles, CA 90067 the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

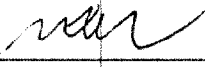
In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Inventor's Signature: 
Yun Hwa CHOI

Date: 2019.9.6

Inventor's Signature: 
Soon Seong CHOI

Date: 2019.9.6

Inventor's Signature: 
JEONG HUN CHO

Date: 2019.9.6